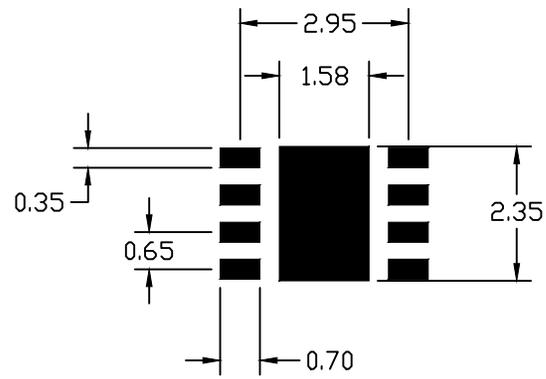


PKG. CODES

[T833+2]  
 [T833+2C]  
 [T833Y+2]  
 [T833MKY+2]  
 [T833+3]  
 [T833+3C]



-DRAWING NOT TO SCALE-



This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depends on many factors unknown to Analog Devices Inc. (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.

TITLE: PACKAGE LAND PATTERN, 8L TDFN, 3X3 MM			
APPROVAL KAI LIU	DOCUMENT CONTROL NO. 90-0059	REV. E	1/1